

Features

- Split Gate Trench MOSFET Technology
- · Excellent Package for Heat Dissipation
- High Density Cell Design for Low R_{DS(on)}
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

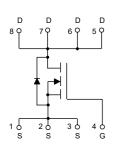
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 20°C/W Junction to Ambient^(Note 2)
- Thermal Resistance: 1.04°C/W Junction to Case

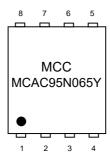
Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V _{DS}	65	V
Gate-Source Volltage		V _{GS}	±20	V
Continuous Drain Current ^(Note 3)	T _C =25°C	_ I _D	95	Α
	T _C =100°C	_ 'D	60	Α
Pulsed Drain Current (Note 4)		I _{DM}	390	Α
Avalanche Energy (Note 5)		E _{AS}	500	mJ
Total Power Dissipation (Note 6)		P _D	120	W

Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. copper, in a still air environment with T_A =25°C.
- 3. The maximum current rating is package limited.
- 4. Repetitive rating; pulse width limited by max. junction temperature.
- 5. V_{DD} =50V, R_G =25 Ω , L=0.5mH, starting T_J =25 $^{\circ}$ C.
- 6. P_D is based on max. junction temperature, using junction-case thermal resistance.

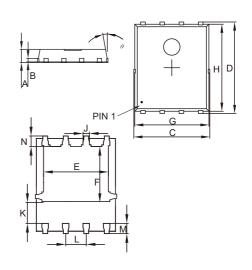
Internal Structure and Marking Code





N-CHANNEL MOSFET

DFN5060



DIMENSIONS						
DIM	INCHES		MM		NOTE	
Dilvi	MIN		MIN MAX		NOTE	
Α	0.031	0.047	0.80	1.20		
В	0.010		0.254		TYP.	
С	0.193	0.222	4.90	5.64		
D	0.232	0.250	5.90	6.35		
E	0.148	0.167	3.75	4.25		
F	0.126	0.154	3.20	3.92		
G	0.189	0.213	4.80	5.40		
Н	0.222	0.239	5.65	6.06		
K	0.045	0.059	1.15	1.50		
J	0.012	0.020	0.30	0.50		
L	0.046	0.054	1.17	1.37		
M	0.012	0.028	0.30	0.71		
N	0.016	0.028	0.40	0.71		

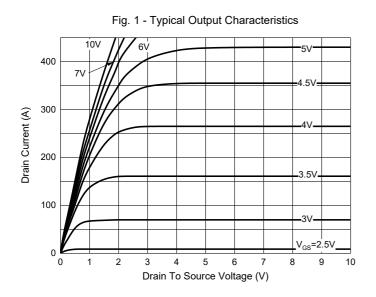


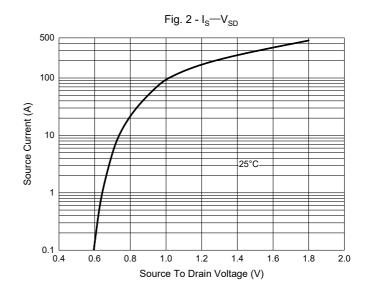
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

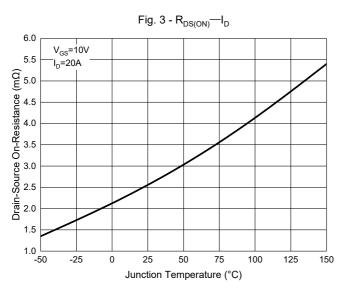
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics				1	1		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	65			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μA	
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.2	1.8	2.2	V	
Drain-Source On-Resistance	Ь	V _{GS} =10V, I _D =20A		2.1	2.5	mΩ	
	R _{DS(on)}	V _{GS} =4.5V, I _D =15A		2.7	3.4	mΩ	
Diode Characteristics				•			
Continuous Body Diode Current	Is				95	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =20A			1.2	V	
Reverse Recovery Time	t _{rr}	L -054 di/dt-4004/		68		ns	
Reverse Recovery Charge	Q _{rr}	I _S =25A,di/dt=100A/μs		73		nC	
Dynamic Characteristics			,	•			
Input Capacitance	C _{iss}			5950			
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V,f=100KHz		1250		pF	
Reverse Transfer Capacitance	C _{rss}			85			
Total Gate Charge	Qg			93			
Gate-Source Charge	Q _{gs}	V _{DS} =50V,V _{GS} =10V,I _D =50A		17		nC	
Gate-Drain Charge	Q_{gd}			14			
Turn-On Delay Time	t _{d(on)}			22.5			
Turn-On Rise Time	t _r	V_{GS} =10V, V_{DD} =30V, I_{D} =25A,		6.7		- ns	
Turn-Off Delay Time	t _{d(off)}	$R_{GEN}=2\Omega$		80.3			
Turn-Off Fall Time	t _f			26.9			

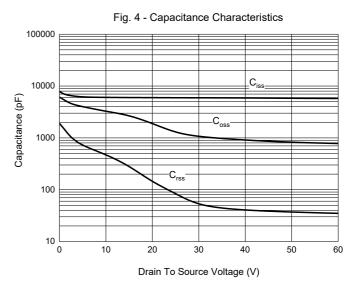


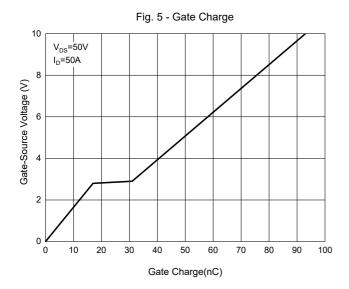
Curve Characteristics

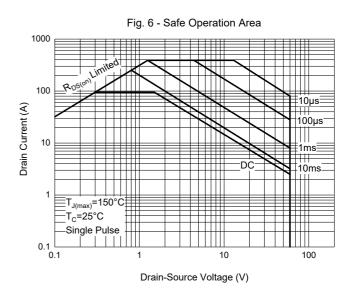






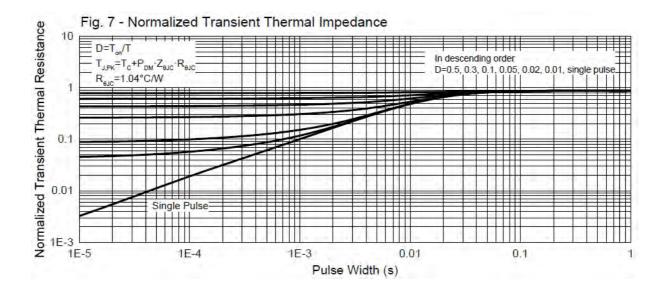








Curve Characteristics



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Ordering Information

Device	Packing		
Part Number-TP	Tape&Reel: 5Kpcs/Reel		

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